DECLARATION - USA PATENT APPLICATION

As a below named inventor, I hereby declare that:

My residence, post office address and citizenship are as stated below next to my name;

I believe I am the original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is

sought on the invention entitled

POLISHING	PAD AND	SEMICONDUCTOR DEVICE MANUFACTURING METHOD
the specificat	ion of whic	h:
(a)	(X)	is attached hereto; or
(b)	()	was filed onas Application No.
		/ or Express Mail No,
		as Application No. not yet known and was amended on(if applicable); or
(c)	()	was described and claimed in PCT International Application No.
		filed on and as amended under PCT Article 19
		on (if any) and/or under PCT Article 34
		on (if any)

I hereby state that I have reviewed and understand the contents of the above identified specification, including the claims, as amended by any amendment referred to above;

I acknowledge the duty to disclose information which is material to the patentability of this application in accordance with Title 37, Code of Federal Regulations, § 1.56;

I hereby claim foreign priority benefits under Title 35, United States Code, § 119 of any foreign application(s) for patent, design or inventor's certificate or any PCT international application(s) listed below and have also identified below any foreign application(s) for patent, design or inventor's certificate or any PCT international application(s) designating at least one country other than the United States of America filed for the same subject matter having a filing date before that of the application(s) of which priority is claimed:

PRIOR FOREIGN APPLICATION(S)

COUNTRY (OR INDICATE IF PCT)	APPLICATION NUMBER	DATE OF FILING (day, month, year)	PRIORITY CLAIMED UNDER 37 U.S.C. § 119	
Japan	2004-069423	11/03/04	(X) YES	NO()
Japan	2004-069498	11/03/04	(X) YES	NO()

I hereby claim the benefit under Title 35, United States Code, § 120 of any United States application(s) listed below, and insofar as the subject matter of each of the claims of this application is not disclosed in the prior United States application in the manner provided by the first paragraph of Title 35, United States Code § 112, I acknowledge the duty to disclose to the U.S. Patent and Trademark Office all information known to me to be material to patentability as defined in Title 37, Code of Federal Regulations, § 1.56, which became available between the filing date of the prior application and the national or PCT international filing date of this application:

Prior U.S.A. Applic	cation(s)			
Application No.:	Filing Date:	Status:		
on information and that willful false st 1001 of Title 18 of	eclare that all statements made herein of belief are believed to be true; and furth atements and the like so made are punifithe United States Code and that such we patent issued thereon.	ner that these staten shable by fine or in	nents were made with inprisonment, or both,	the knowledge under Section
Full name of first in	nventor: Tetsuo SHIMOMURA			
Inventor's signature	Low Shamma Day	30th Month	August	Year <u>2006</u>
Residence (city and	l country): Ohtsu-shi, Japan			
Citizenship: Japan				
Post Office Addres	s: c/o Toyo Boseki Kabushiki Kaisha Re: 520-0292 Japan	search Center, 1-1, I	Katata 2-chome, Ohtsu	-shi, Shiga
Full name of second	d inventor: Masahiko NAKAMORI			
Inventor's signature	Masahiko Makamari Day	30th Month	August	_Year <u>200</u> 6
Residence (city and	l country): Ohtsu-shi, Japan			
Citizenship: Japan				
Post Office Addres	s: c/o Toyo Boseki Kabushiki Kaisha Re: 520-0292 Japan	search Center, 1-1, 1	Katata 2-chome, Ohtsu	-shi, Shiga
Full name of third i	inventor: Takatoshi YAMADA			
Inventor's signature	. Jakatoshi Yamada Day	30th Month	August	Year <u>2006</u>
Residence (city and	d country): Ohtsu-shi, Japan			
Citizenship: Japan				
Post Office Address	s: c/o Toyo Boseki Kabushiki Kaisha Re 520-0292 Japan	search Center, 1-1,	Katata 2-chome, Ohtsu	-shi, Shiga

Full name of fourth inventor: Kazuyuki OGAWA	
Inventor's signature Kazuyuki Ozawa Day 30th Month August Year 20	06
Residence (city and country): Osaka-shi, Japan	
Citizenship: Japan	
Post Office Address: c/o Toyo Tire & Rubber Co., Ltd., 17-18, Edobori 1-chome, Nishi-ku, Osaka-shi, Osaka 550-8661 Japan	
Full name of fifth inventor: Atsushi KAZUNO	
Inventor's signature <u>Utanski Xayuno</u> Day 30th Month August Year 2	006
Residence (city and country): Osaka-shi, Japan	
Citizenship: Japan	
Post Office Address: c/o Toyo Tire & Rubber Co., Ltd., 17-18, Edobori 1-chome, Nishi-ku, Osaka-shi, Osaka 550-8661 Japan	
Full name of sixth inventor: Masahiro WATANABE	
Inventor's signature <u>Inaxahura Watanake</u> Day 30th Month August Year 2	<u>006</u>
Residence (city and country): Osaka-shi, Japan	

Post Office Address: c/o Toyo Tire & Rubber Co., Ltd., 17-18, Edobori 1-chome, Nishi-ku, Osaka-shi,

Send Correspondence To: KNOBBE, MARTENS, OLSON & BEAR, LLP Customer No. 20,995

Osaka 550-8661 Japan

Citizenship: Japan

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